100A 650V Trench Fieldstop IGBT with anti-parallel diode SRE100N065FSU2DB

General Description

The SRE100N065FSU2DB is a Field Stop Trench IGBT with anti-parallel diode, which offers ultra-low conduction loss, high energy efficiency for switching applications such as Inverter, PFC, Converter, etc.

The SRE100N065FSU2DB package is TO-247.

Features

- High Breakdown Voltage to 700V@Tj=25℃
- Advanced Trench Fieldstop technology
  - Smooth Switching Off with Lower Spike
  - High Ruggedness, Temperature Stability
  - Easy Parallel Switching Capability due to Positive Temperature Coefficient in $V_{CE(SAT)}$
- Low $V_{CE(SAT)}$
- Enhanced Avalanche Capability
- Non-Automotive Qualified

Application

- PFC application
- Inverter & Solar
- Converter with high switching frequency

Symbol

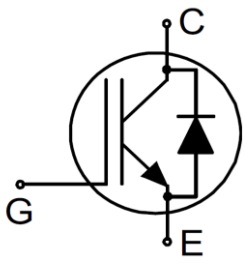
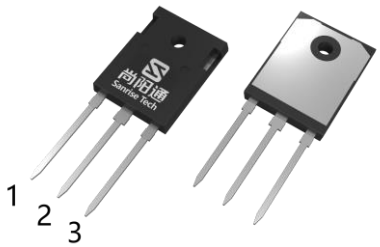


Figure 1 Symbol of SRE100N065FSU2DB

Package Type



TO-247

Pin 1- Gate
Pin 2&backside- Collector
Pin 3-Emitter

Figure 2 Package Type of SRE100N065FSU2DB

Ordering Information

SRE100N065FSU2DB□□–□

Circuit Type
Package
T: TO-247

E: Lead Free
Blank: Tube
TR: Tape & Reel

Package	Part Number	Marking ID	Packing Type
TO-247	SRE100N065FSU2DBT-G2	SRE100N065FSU2DBT-G2	Tube

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Absolute Maximum Ratings

Parameter		Symbol	Rating	Unit
Collector-emitter voltage		V_{CES}	650	V
Gate-emitter Voltage		V_{GES}	±20	V
Transient Gate-emitter Voltage			±30	V
Continuous Collector Current	T_C=25ºC	I_C	150	A
	T_C=100ºC		100	
Pulsed Collector Current, Limited by T_{Jmax}		I_{CM}	400	A
Diode Continuous Collector Current	T_C=25ºC	I_F	120	A
	T_C=100ºC		100	A
Diode Pulsed Current, Limited by T_{Jmax}		I_{FM}	320	A
Power Dissipation	T_C=25ºC	P_{tot}	394	W
	T_C=100ºC		197	
Short Circuit withstand time: V_{GE}=15V,Vcc≤400V,Tj_start=25℃; Allow number of short circuits<1000; Time between short circuits:1.0S;		tsc	6	us
Operating Junction Temperature Range		T_J	-40 ~ 175(1)	ºC
Storage Temperature		T_{STG}	-55 ~ 150	ºC
Lead Temperature (Soldering, 10 sec)		T_{LEAD}	260	ºC

Note:

1. Reliability testing conducted at T_{Jmax}=175℃.

Thermal Resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
IGBT thermal Resistance，Junction-to-Case	R_{thJC}	-	-	0.38	ºC/W
Diode thermal Resistance，Junction-to-Case	R_{thJC}	-	-	0.45	
Thermal Resistance，Junction-to-Ambient	R_{thJA}	-	-	40	

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Electrical Characteristics

T_J = 25ºC, unless otherwise specified.

Parameter		Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics							
Collector-emitter Breakdown Voltage		BV_{CES}	V_{GE}=0V, I_C=1mA	700			V
Gate Threshold Voltage		$V_{GE(th)}$	V_{CE}=V_{GE}, I_C=250uA	3.8	4.5	5.4	V
Collector-emitter saturation voltage		V_{CEsat}	V_{GE}=15V, I_C=100A, T_J=25ºC		1.57	1.9	V
			T_J=125ºC		1.89		V
			T_J=175ºC		2.08		V
Zero Gate Voltage Collector Current		I_{CES}	V_{CE}=650V,V_{GE}=0V T_J=25ºC		0.1	40	uA
			T_J=175ºC			1	mA
Gate-emitter Leakage Current	Forward	I_{GESF}	V_{GE}=20V, V_{CE}=0V			100	nA
	Reverse	I_{GESR}	V_{GE}=-20V, V_{CE}=0V			-100	nA
Dynamic Characteristics							
Input Capacitance		C_{IES}	V_{CE}=25V, V_{GE}=0V, f=1 MHz		3750		pF
Output Capacitance		C_{OES}			350		
Reverse Transfer Capacitance		C_{RES}			40		
Gate Resistance		R_G	f=1MHz,Open Drain		1.7		Ω
Turn-on Delay Time		$t_{d(on)}$	T_J=25ºC V_{CC}=400V, I_C=100A R_G=10Ω, V_{GE}=0/15V Energy losses include "tail" and diode reverse recovery		67		ns
Rise Time		t_r			96		ns
Turn-off Delay Time		$t_{d(off)}$			262		ns
Fall Time		t_f			153		ns
Turn-on energy		E_{on}			4.0		mJ
Turn-off energy		E_{off}			1.4		mJ
Total switching energy		E_{ts}			5.4		mJ
Turn-on Delay Time		$t_{d(on)}$	T_J=150ºC V_{CC}=400V,I_C=100A R_G=10Ω, $_{GE}$=0/15V Energy losses include "tail" and diode reverse recovery		67		ns
Rise Time		t_r			114		ns
Turn-off Delay Time		$t_{d(off)}$			289		ns
Fall Time		t_f			168		ns
Turn-on energy		E_{on}			4.6		mJ
Turn-off energy		E_{off}			1.8		mJ
Total switching energy		E_{ts}			6.4		mJ
Gate to Emitter Charge		Q_{GE}	V_{CC}=400V,I_C=100A V_{GE}=0 to 15V		42		nC
Gate to Collector Charge		Q_{GC}			72		
Gate Charge Total		Q_G			162		

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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Reverse Diode Characteristics						
Diode Forward Voltage	V_F	I_F=50A T_J=25ºC		1.39	1.7	V
		I_F=50A T_J=125ºC		1.23		
		I_F=50A T_J=175ºC		1,13		
		I_F=100A T_J=25ºC		1.71	2.0	
		I_F=100A T_J=125ºC		1.62		
		I_F=100A T_J=175ºC		1.55		
Reverse Recovery Time	t_{rr}	T_J=25ºC V_R=400V, I_F=50A dI_F/dt=840A/μs		190		ns
Reverse Recovery Charge	Q_{rr}			1150		nC
Peak Reverse Recovery Current	I_{rrm}			18		A
Reverse Recovery Time	t_{rr}	T_J=25ºC V_R=400V, I_F=100A dI_F/dt=660A/μs		174		ns
Reverse Recovery Charge	Q_{rr}			760		nC
Peak Reverse Recovery Current	I_{rrm}			14		A

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Main Site:

- Headquarter

Shenzhen Sanrise Technology Co., LTD.

A1206, Skyworth building, No. 008, gaoxinnan 1st Road, Gaoxin District, Yuehai street, Nanshan District, ShenZhen, P.R. China

Tel: +86-755-22953335

Fax: +86-755-22916878

- Shanghai Office

Shenzhen Sanrise Technology Co., LTD.

Rm.401, Building B, No. 666, Zhangheng Road, Zhangjiang Hi-Tech Park, Shanghai, P.R.China

Tel: +86-21-68825918